PATENT ATTORNEY DOCKET NO.: 041993-5349

ABSTRACT OF THE DISCLOSURE

A method for forming a pattern using a printing process is disclosed in the present invention. The method includes providing a substrate having an etching layer formed thereon, locating a master having at least one opening in the etching layer, filling a resist in the at least one opening of the master, and separating the master from the substrate to leave the resist on the substrate.